OSRAM KW CELMM1.TG **Datasheet**



OSLON® Boost HM

KW CELMM1.TG

OSLON Boost HM utilizes the high current capability of the latest chip generation in a special package for good thermal behaviour. The LED is characterized by a high luminance of up to 255 cd / mm² and a high luminous flux. Therefore this LED is ideally suited as a powerful light source for ultra-slim headlamp designs.





Applications

- Dynamic Forward Lighting

- Static Forward Lighting

Features

- Package: Ceramic package

- Chip technology: UX:3

- Typ. Radiation: 120° (Lambertian emitter)

- Color: Cx = 0.325, Cy = 0.345 acc. to CIE 1931 (white)

- Corrosion Robustness Class: 3A

- Qualifications: AEC-Q102 Qualified

- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

- Color over angle: Better than passus 3.7.2.1 of supplement proposal 7 to ECE reg. 128



Ordering Information

Ordering Code Type Luminous Flux 1) Mounting methode

 $I_{\rm F}$ = 1500 mA

375 ... 585 lm KW CELMM1.TG-S3SB-4L07M0-8F8H Тор Q65113A0743



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature ²⁾	T _{op}	min.	-40 °C
	op.	max.	135 °C
Storage Temperature	T _{stg}	min.	-40 °C
	9	max.	135 °C
Junction Temperature	T_{j}	max.	150 °C
Junction Temperature for short time applications*	T_{j}	max.	175 °C
Forward current	I _F	min.	50 mA
$T_S = 25 ^{\circ}C$		max.	1650 mA
Forward current pulsed D = 0.005 ; T _s = 25 °C	I _{F pulse}	max.	2000 mA
Surge current	I _{FS}	max.	2500 mA
$t \le 10 \ \mu s; \ D = 0.005 \ ; \ T_{_{\rm S}} = 25 \ ^{\circ}{\rm C}$	10		
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV
Reverse current 3)	I _R	max.	200 mA

^{*} The median lifetime (L70/B50) for Tj = 175° C is 100h.



Characteristics

 I_F = 1500 mA; T_S = 25 °C

Parameter	Symbol	Values	
Chromaticity Coordinate 4)	Сх	typ.	0.325
	Су	typ.	0.345
Viewing angle at 50% I _v	2φ	typ.	120 °
Forward Voltage 5)	V_{F}	min.	3.00 V
I _F = 1500 mA	·	typ.	3.41 V
		max.	3.75 V
Reverse voltage (ESD device)	$V_{R ESD}$	min.	45 V
Reverse voltage ³⁾ I _R = 20 mA	V_{R}	max.	1.2 V
Real thermal resistance junction/solderpoint ⁶⁾	$R_{thJSreal}$	typ.	6.7 K / W
·	tilos real	max.	8.1 K / W
Electrical thermal resistance junction/solderpoint ⁶⁾	R _{thJS elec.}	typ.	5.0 K / W
with efficiency η_e = 26 %	thoo elec.	max.	6.0 K / W



Brightness Groups

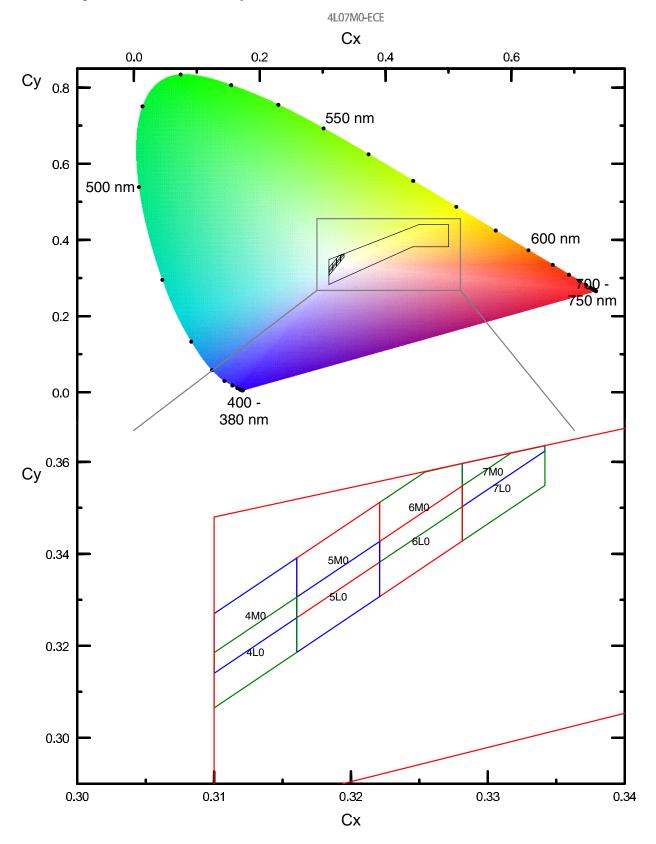
Group	Luminous Flux ¹⁾ $I_F = 1500 \text{ mA}$ min. Φ_V	Luminous Flux ¹⁾ $I_F = 1500 \text{ mA}$ max. Φ_V	
S3	375 lm	395 lm	
S4	395 lm	415 lm	
S5	415 lm	435 lm	
S6	435 lm	460 lm	
S7	460 lm	485 lm	
S8	485 lm	510 lm	
S9	510 lm	535 lm	
SA	535 lm	560 lm	
SB	560 lm	585 lm	

Forward Voltage Groups

Group	Forward Voltage ⁵⁾ I _F = 1500 mA min. V _F	Forward Voltage ⁵⁾ I _F = 1500 mA max. V _F	
8F	3.00 V	3.25 V	
8G	3.25 V	3.50 V	
8H	3.50 V	3.75 V	



Chromaticity Coordinate Groups





Group	Cx	Су	Group	Cx	Су	Group	Cx	Су
4L0	0.3100	0.3065	5M0	0.3160	0.3261	7L0	0.3281	0.342
	0.3100	0.3185		0.3160	0.3391		0.3281	0.354
	0.3160	0.3306		0.3221	0.3512		0.3317	0.362
	0.3160	0.3186		0.3221	0.3382		0.3342	0.363
4M0	0.3100	0.3140	6L0	0.3221	0.3307		0.3342	0.354
	0.3100	0.3270		0.3221	0.3427	7M0	0.3281	0.350
	0.3160	0.3391		0.3281	0.3548		0.3281	0.359
	0.3160	0.3261		0.3281	0.3428		0.3342	0.363
5L0	0.3160	0.3186	6M0	0.3221	0.3382		0.3342	0.362
	0.3160	0.3306		0.3221	0.3512			
	0.3221	0.3427		0.3254	0.3578			
	0.3221	0.3307		0.3281	0.3597			
				0.3281	0.3503			

KW CELMM1.TG DATASHEET



Group Name on Label

Example: S3-4L0-8F

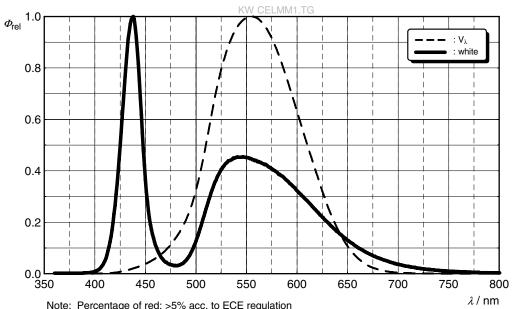
Brightness	Color Chromaticity	Forward Voltage

S3 4L0 8F



Relative Spectral Emission 7)

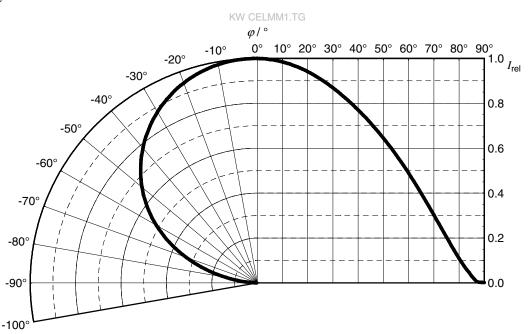
 Φ_{rel} = f (λ); I $_{F}$ = 1500 mA; T $_{J}$ = 25 °C



Note: Percentage of red: >5% acc. to ECE regulation Percentage of UV: <10^{.5}W/lm acc. to ECE regulation

Radiation Characteristics 7)

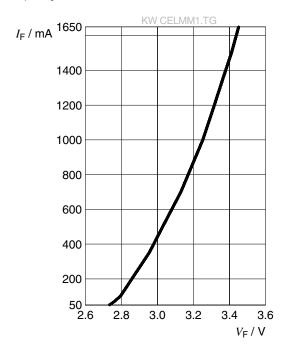
 $I_{rel} = f (\phi); T_J = 25 °C$





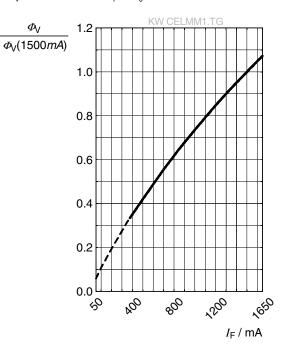
Forward current 7)

$$I_F = f(V_F); T_J = 25 \, ^{\circ}C$$



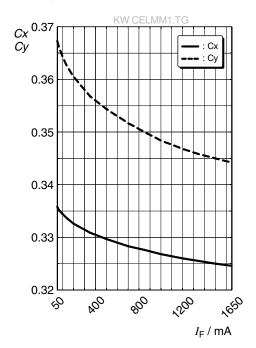
Relative Luminous Flux 7), 8)

$$\Phi_{v}/\Phi_{v}(1500 \text{ mA}) = f(I_{F}); T_{J} = 25 \text{ }^{\circ}\text{C}$$



Chromaticity Coordinate Shift 7)

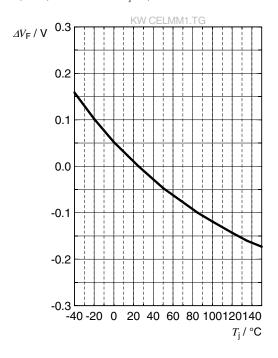
Cx, Cy =
$$f(I_F)$$
; $T_J = 25$ °C





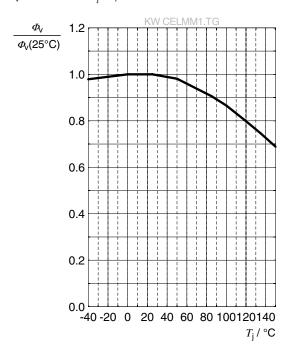
Forward Voltage 7)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25~^{\circ}C) = f(T_{_j}); \ I_{_F} = 1500~mA$$



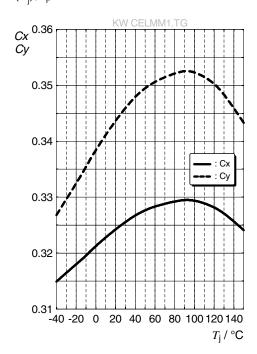
Relative Luminous Flux 7)

$$\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 1500 \text{ mA}$$



Chromaticity Coordinate Shift 7)

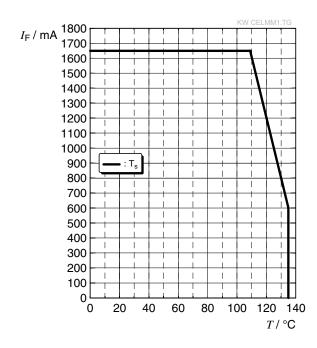
$$Cx$$
, $Cy = f(T_i)$; $I_F = 1500 \text{ mA}$





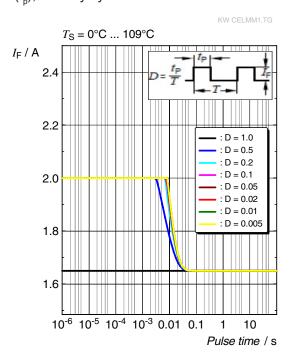
Max. Permissible Forward Current 6)

 $I_{\scriptscriptstyle F} = f(T)$



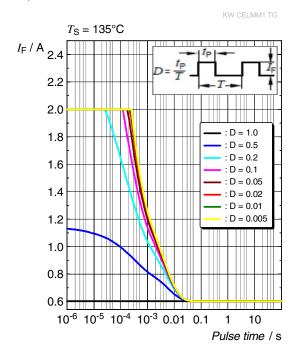
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; D: Duty cycle



Permissible Pulse Handling Capability

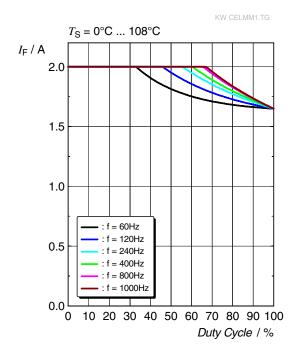
 $I_F = f(t_D)$; D: Duty cycle





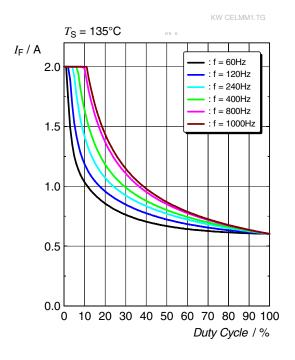
Permissible F. Handling Capability

f: Frequency



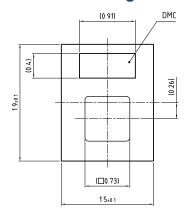
Permissible F. Handling Capability

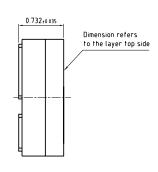
f: Frequency

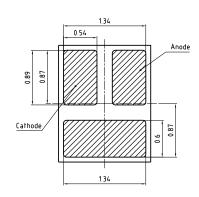




Dimensional Drawing 9)







general tolerance ± 0.05 lead finish Au

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Further Information:

Approximate Weight: 7.0 mg

Corrosion test: Class: 3A

Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC

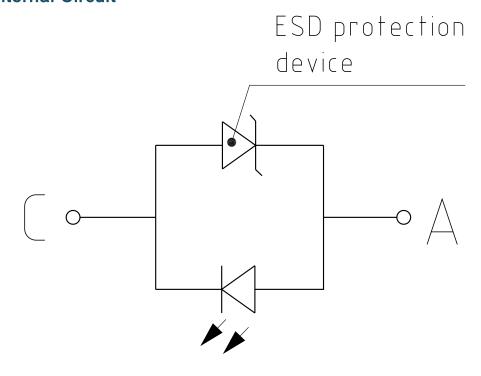
60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the

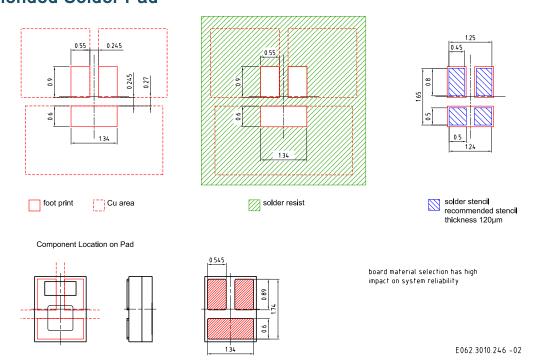
Chip.



Electrical Internal Circuit



Recommended Solder Pad 9)

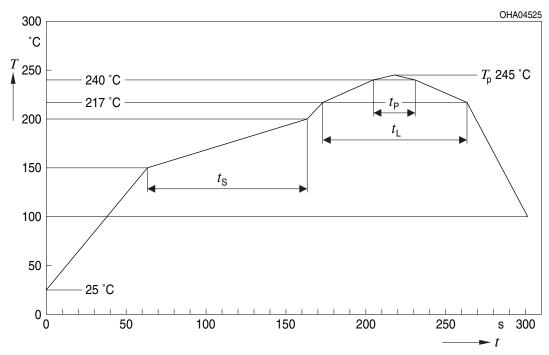


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning. To ensure a high solder joint reliability and to minimize the risk of solder joint cracks, the customer is responsible to evaluate the combination of PCB board and solder paste material for his application.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



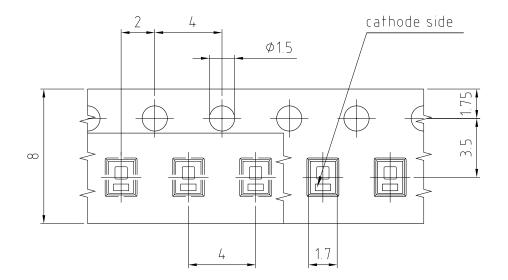
K/s
S
K/s
°C
S
°C
S
K/s
S

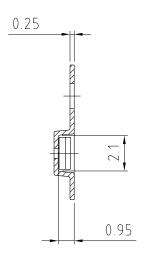
All temperatures refer to the center of the package, measured on the top of the component

^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



Taping 9)

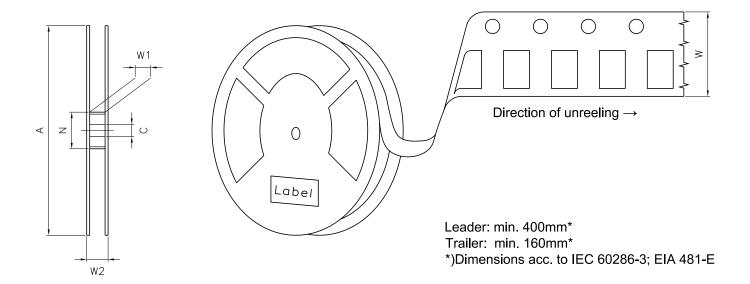




C63062-A4372-B7-02



Tape and Reel 10)

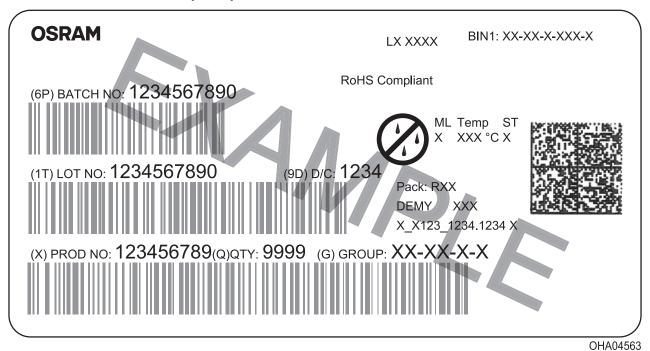


Reel Dimensions

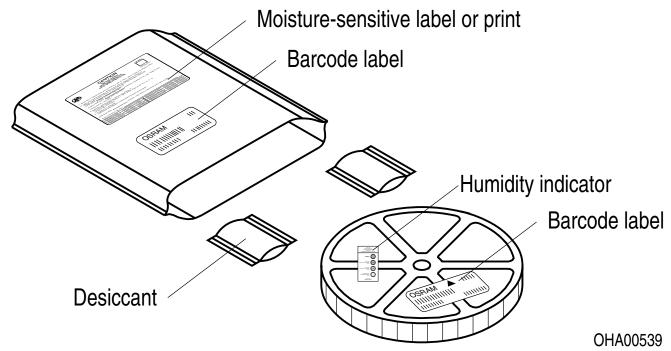
Α	W	N_{\min}	W_1	$W_{2 max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	4000



Barcode-Product-Label (BPL)



Dry Packing Process and Materials 9)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class moderate risk (exposure time 0.25 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers avoid device exposure to aggressive substances during storage, production, and use.

For further application related information please visit https://ams-osram.com/support/application-notes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



Glossary

- Brightness: Brightness values are measured during a current pulse of typically 1 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Operating Temperature: The Operating Temperatur Top is referenced to the Solderpoint Ts of this device. Proper current derating must be observed to maintain junction temperature below the maximum.
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Chromaticity coordinate groups: Chromaticity coordinates are measured during a current pulse of typically 1 ms, with an internal reproducibility of ±0.005 and an expanded uncertainty of ±0.01 (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 1 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).
- 6) Thermal Resistance: Rth max is based on statistic values (6σ) used for Derating.
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision	Revision History				
Version	Date	Change			
1.0	2019-12-05	Initial Version			
1.1	2021-03-15	Product Image Features Ordering Information Characteristics Brightness Groups Chromaticity Coordinate Groups Group Name on Label Electro - Optical Characteristics (Diagrams) Derating (Diagrams) Dimensional Drawing Recommended Solder Pad Reel Dimensions Glossary			
1.2	2021-07-26	Features			

New Layout

Applications

1.3

2024-02-08



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

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Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved





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